

Maximum Ratings at Tj = 25 °C unless otherwise specified							
Parameter	Symbol	Value	Unit				
Drain source voltage	V _{DS}	60	V				
Drain source voltage for short circuit protection	V _{DS(SC)}	32					
Continuous input current 1)	I _{IN}		mA				
$-0.2V \le V_{IN} \le 10V$		no limit					
$V_{\rm IN}$ < -0.2V or $V_{\rm IN}$ > 10V		<i>I</i> _{IN} ≤ 2					
Operating temperature	T _i	- 40 +150	°C				
Storage temperature	T _{stg}	- 55 +150					
Power dissipation	P _{tot}	50	W				
$T_{\rm C} = 25 \ ^{\circ}{\rm C}$							
Unclamped single pulse inductive energy	E _{AS}	1000	mJ				
$I_{D(ISO)} = 3.5 \text{ A}$							
Electrostatic discharge voltage (Human Body Model)	V _{ESD}	3000	V				
according to MIL STD 883D, method 3015.7 and							
EOS/ESD assn. standard S5.1 - 1993							
Load dump protection $V_{\text{LoadDump}}^{(2)} = V_{\text{A}} + V_{\text{S}}$	V _{LD}						
V _{IN} =low or high; V _A =13.5 V							
t _d = 400 ms, <i>R</i> I = 2 Ω, <i>I</i> D=0,5*3.5A		75					
t_{d} = 400 ms, R_{I} = 2 Ω , I_{D} = 3.5A		70					
DIN humidity category, DIN 40 040		E					
IEC climatic category; DIN IEC 68-1		40/150/56					

Maximum Ratings at Tj = 25 °C unless otherwise specified

Thermal resistance

junction - case:	R _{thJC}	2.5	K/W
junction - ambient:	R _{thJA}	75	
SMD version, device on PCB: ³⁾	R _{thJA}	45	

¹In case of thermal shutdown a minimum sensor holding current of 500 μ A has to be guaranteed (see also page 3).

 $^{^{2}}V_{\text{Loaddump}}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839

 $^{^3}$ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm 2 (one layer, 70 μ m thick) copper area for Drain connection. PCB mounted vertical without blown air.



BTS 117

Electrical Characteristics

Parameter	Symbol		Unit		
at T _j =25°C, unless otherwise specified		min.	typ.	max.]
Characteristics					•
Drain source clamp voltage	V _{DS(AZ)}	60	-	73	V
<i>T</i> _j = - 40+ 150°C, <i>I</i> _D = 10 mA					
Off state drain current	I _{DSS}	-	-	5	μA
$V_{\rm DS}$ = 32 V, $T_{\rm j}$ = -40+150 °C, $V_{\rm IN}$ = 0 V					
Input threshold voltage	V _{IN(th)}	1.3	1.7	2.2	V
<i>I</i> _D = 0.7 mA					
Input current - normal operation, <i>I</i> _D < <i>I</i> _{D(lim)} :	/IN(1)	-	30	60	μA
$V_{\rm IN}$ = 10 V					
Input current - current limitation mode, $I_D = I_{D(lim)}$:	I _{IN(2)}	-	120	300	
$V_{\rm IN}$ = 10 V					
Input current - after thermal shutdown, <i>I</i> _D =0 A:	I _{IN(3)}	800	2200	4000	
$V_{\rm IN}$ = 10 V					
Input holding current after thermal shutdown ¹⁾	I _{IN(H)}				
<i>T</i> _j = 25 °C		500	-	-	
<i>T</i> _j = 150 °C		300	-	-	
On-state resistance	R _{DS(on)}				mΩ
$V_{\rm IN}$ = 5 V, $I_{\rm D}$ = 3.5 A, $T_{\rm j}$ = 25 °C		-	90	120	
$V_{\rm IN}$ = 5 V, $I_{\rm D}$ = 3.5 A, $T_{\rm j}$ = 150 °C		-	180	240	
On-state resistance	R _{DS(on)}				
$V_{\rm IN}$ = 10 V, $I_{\rm D}$ = 3.5 A, $T_{\rm j}$ = 25 °C		-	80	100	
$V_{\rm IN}$ = 10 V, $I_{\rm D}$ = 3.5 A, $T_{\rm j}$ = 150 °C		-	160	200	
Nominal load current (ISO 10483)	I _{D(ISO)}	3.5	-	-	A
$V_{\rm IN}$ = 10 V, $V_{\rm DS}$ = 0.5 V, $T_{\rm C}$ = 85 °C					

¹If the input current is limited by external components, low drain currents can flow and heat the device. Auto restart behaviour can occur.



Electrical Characteristics

Parameter	Symbol		Unit		
at T _j =25°C, unless otherwise specified		min.	typ.	max.]
Characteristics	·				
Initial peak short circuit current limit	I _{D(SCp)}	-	25	-	A
V _{IN} = 10 V, V _{DS} = 12 V					
Current limit ¹⁾	I _{D(lim)}	7	10	15	
$V_{\rm IN}$ = 10 V, $V_{\rm DS}$ = 12 V, $t_{\rm m}$ = 350 µs,					
<i>T</i> _j = -40+150 °C					
Dynamic Characteristics					
Turn-on time $V_{\rm IN}$ to 90% $I_{\rm D}$:	t _{on}	-	40	70	μs
$R_{\rm L}$ = 4.7 Ω , $V_{\rm IN}$ = 0 to 10 V, $V_{\rm bb}$ = 12 V					
Turn-off time $V_{\rm IN}$ to 10% $I_{\rm D}$:	t _{off}	-	70	150]
$R_{\rm L}$ = 4.7 Ω, $V_{\rm IN}$ = 10 to 0 V, $V_{\rm bb}$ = 12 V					
Slew rate on 70 to 50% V _{bb} :	-dV _{DS} /dt _{on}	-	1	3	V/µs
$R_{\rm L}$ = 4.7 Ω , $V_{\rm IN}$ = 0 to 10 V, $V_{\rm bb}$ = 12 V					
Slew rate off 50 to 70% V _{bb} :	dV _{DS} /dt _{off}	-	1	3	
$R_{\rm L}$ = 4.7 Ω, $V_{\rm IN}$ = 10 to 0 V, $V_{\rm bb}$ = 12 V					

Protection Functions

Thermal overload trip temperature	τ _{it}	150	165	-	°C
Unclamped single pulse inductive energy	E _{AS}				mJ
$I_{\rm D}$ = 3.5 A, $T_{\rm j}$ = 25 °C, $V_{\rm bb}$ = 32 V		1000			
$I_{\rm D}$ = 3.5 A, $T_{\rm j}$ = 150 °C, $V_{\rm bb}$ = 32 V		225			

Inverse Diode

Inverse diode forward voltage	V _{SD}	-	1	-	V
$I_{\rm F}$ = 5*3.5A, $t_{\rm m}$ = 300 µS, $V_{\rm IN}$ = 0 V					

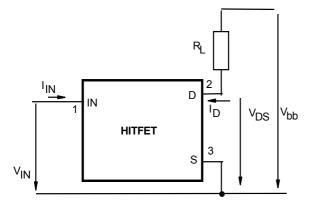
¹Device switched on into existing short circuit (see diagram Determination of I $_{D(lim)}$). If the device is in on condition and a short circuit occurs, these values might be exceeded for max. 50 µs.



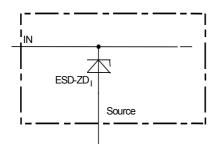


Block Diagramm

Terms

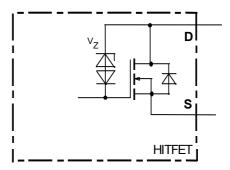


Input circuit (ESD protection)

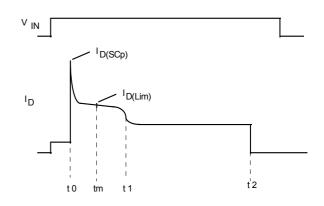


ESD zener diodes are not designed for DC current > 2 mA @ V_{IN} >10V.

Inductive and overvoltage output clamp



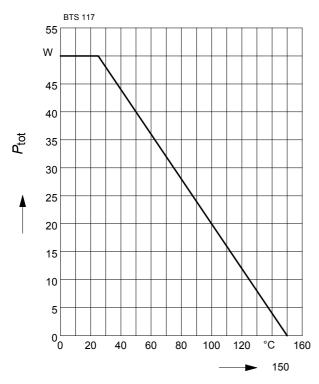
Short circuit behaviour



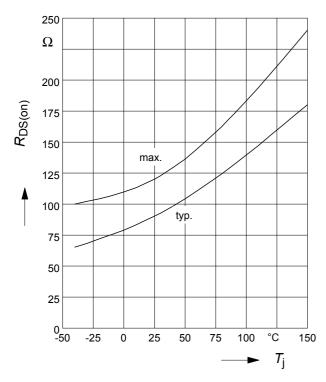
- t₀: Turn on into a short circuit
- tm: Measurementpoint for ID(lim)
- t₁: Activation of the fast temperature sensor and regulation of the drain current to a level where the junction temperature remains constant.
- t₂: Thermal shutdown caused by the second temperature sensor, achieved by an integrating measurement.



Maximum allowable power dissipation $P_{tot} = f(T_c)$

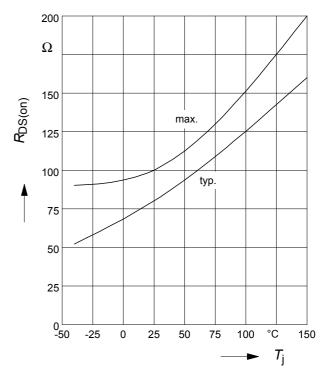


On-state resistance R_{ON} = f(T_i); I_D= 3.5A; V_{IN}=5V

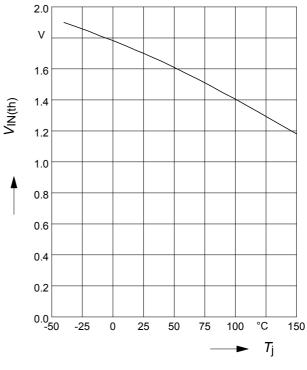


On-state resistance

R_{ON} = f(T_i); I_D=3.5A; V_{IN}=10V



Typ. input threshold voltage V_{IN(th)} = f(T_j); I_D=0.7mA; V_{DS}=12V

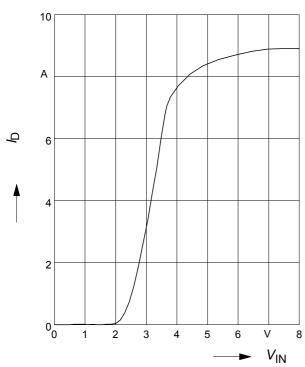


19.05.2000



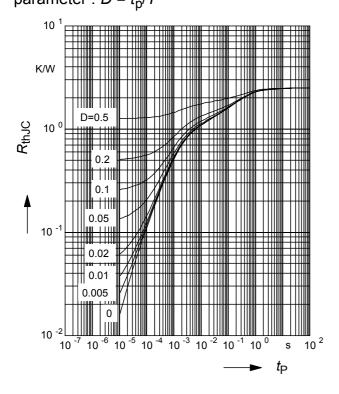


Typ. transfer characteristics I_D = f(V_{IN}); V_{DS}=12V; T_j=25°C



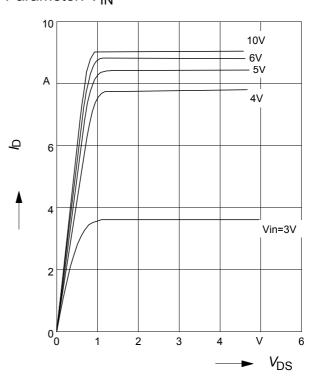
Transient thermal impedance

 $Z_{\text{thJC}} = f(t_p)$ parameter : $D = t_p/T$



Typ. output characteristic

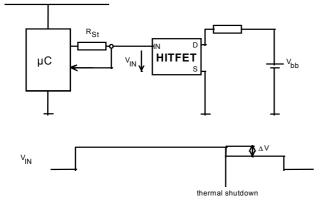
 $I_D = f(V_{DS}); T_j=25^{\circ}C$ Parameter: V_{IN}





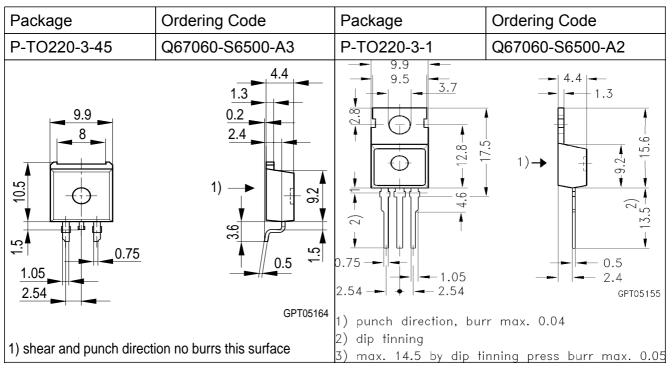
Application examples:

Status signal of thermal shutdown by monitoring input current



 $\Delta V = R_{ST} * I_{IN(3)}$





Published by Infineon Technologies AG, Bereichs Kommunikation St.-Martin-Strasse 53, D-81541 München © Infineon Technologies AG 1999 All Rights Reserved.

Attention please!

The information herein is given to describe certain components and shall not be considered as warranted characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Infineon Technologies is an approved CECC manufacturer.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office in Germany or our Infineon Technologies Representives worldwide (see address list).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.